



### General Description

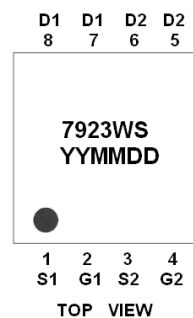
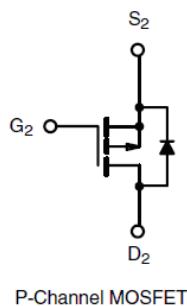
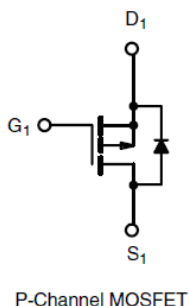
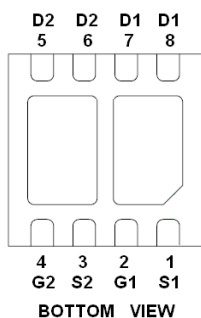
AFP7923WS, P-Channel enhancement mode MOSFET, uses Advanced Trench Technology to provide excellent  $R_{DS(ON)}$ , low gate charge.

These devices are particularly suited for low voltage power management, such as smart phone and notebook computer and other battery powered circuits, and low in-line power loss are needed in commercial industrial surface mount applications.

### Features

- $I_D = -8A, R_{DS(ON)} = 55m\Omega @ V_{GS} = 10V$
- $I_D = -6A, R_{DS(ON)} = 75m\Omega @ V_{GS} = 4.5V$   
 $I_D = -4A, R_{DS(ON)} = 95m\Omega @ V_{GS} = -2.5V$
- Super high density cell design for extremely low  $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability
- DFN3X3-8L package design

### Pin Description ( DFN3X3-8L )



### Application

- DC/DC Conversion
- Load Switch
- DC FAN

### Pin Define

Pin	Symbol	Description
1	S1	Source 1
2	G1	Gate 1
3	S2	Source 2
4	G2	Gate 2
5	D2	Drain 2
6	D2	Drain 2
7	D1	Drain 1
8	D1	Drain 1

### Ordering Information

Part Ordering No.	Part Marking	Package	Unit	Quantity
AFP7923WSFN338RG	7923WS	DFN3X3-8L	Tape & Reel	5000 EA

※ YY year code

※ MM month code

※ DD date code

※ AFP7923WSFN338RG : 13" Tape & Reel ; Pb- Free ; Halogen -Free



**Absolute Maximum Ratings**

(T<sub>A</sub>=25°C Unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DSS</sub>	-30	V
Gate –Source Voltage	V <sub>GSS</sub>	±12	V
Continuous Drain Current(T <sub>J</sub> =150°C)	I <sub>D</sub>	T <sub>A</sub> =25°C	-8.0
		T <sub>A</sub> =70°C	-6.0
Pulsed Drain Current	I <sub>DM</sub>	-30	A
Continuous Source Current(Diode Conduction)	I <sub>S</sub>	-10	A
Power Dissipation	P <sub>D</sub>	T <sub>C</sub> =25°C	28
		T <sub>C</sub> =70°C	15
		T <sub>A</sub> =25°C	3.2
		T <sub>A</sub> =70°C	2.0
Operating Junction Temperature	T <sub>J</sub>	150	°C
Storage Temperature Range	T <sub>STG</sub>	-55/150	°C
Thermal Resistance Junction-to-Case (Drain)	R <sub>θJC</sub>	5	°C/W
Thermal Resistance-Junction to Ambient	R <sub>θJA</sub>	40	

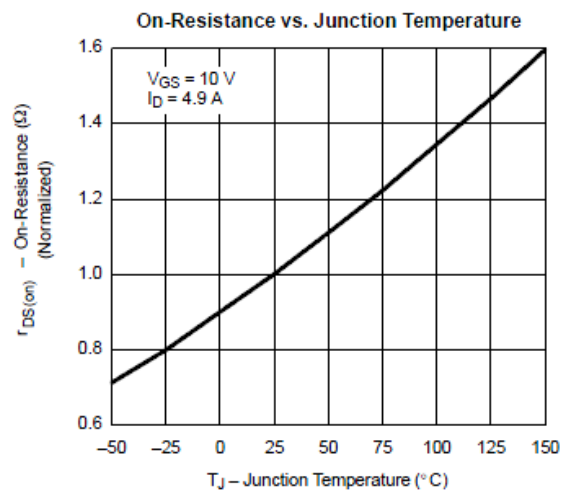
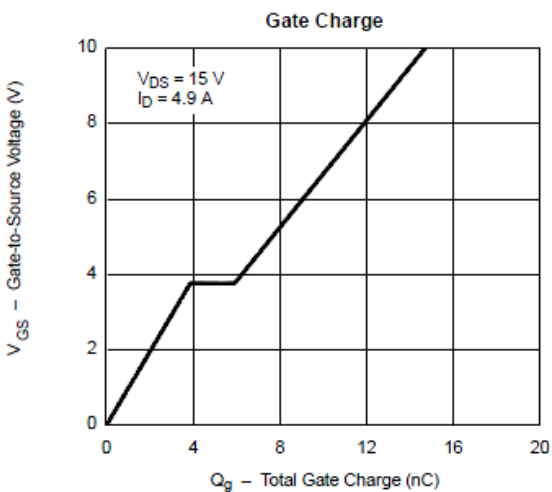
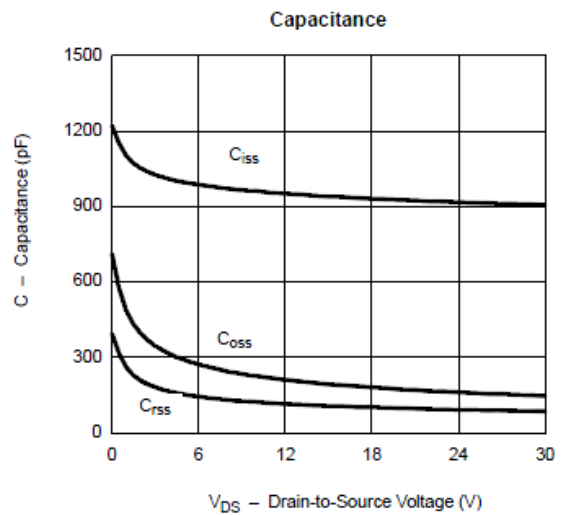
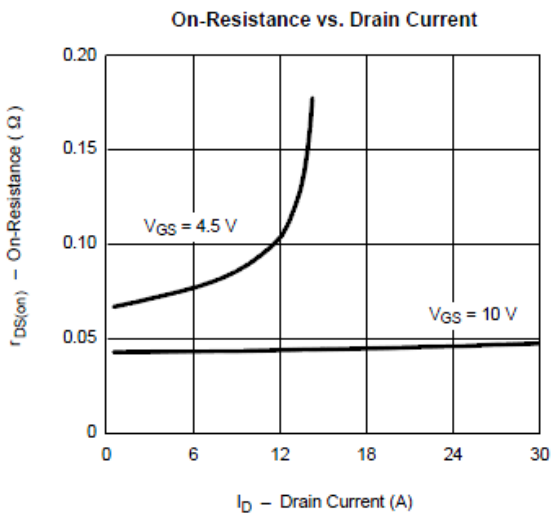
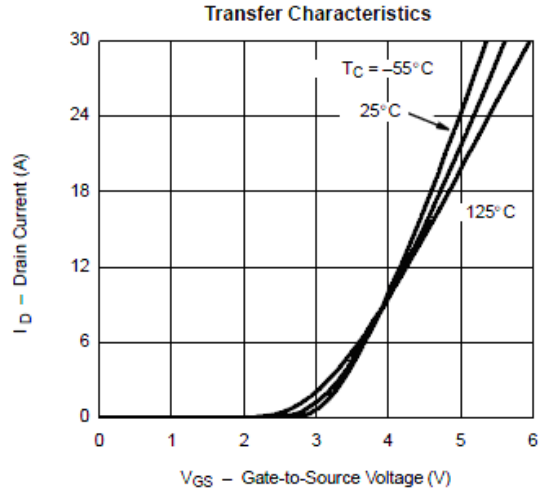
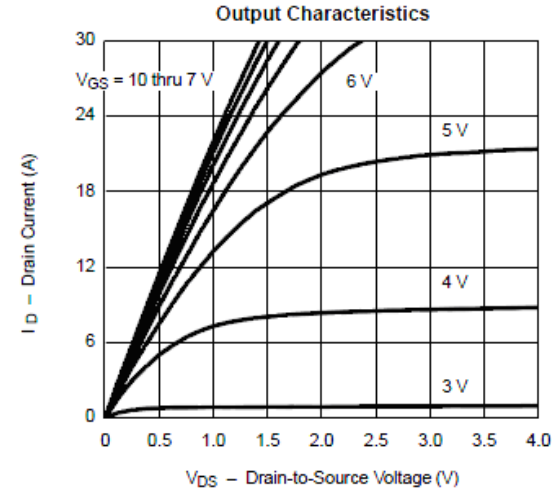
**Electrical Characteristics ( P-Channel )**

(T<sub>A</sub>=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =-250uA	-30			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250uA	-0.6		-1.1	
Gate Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±12V			±100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =-24V, V <sub>GS</sub> =0V			1	uA
		V <sub>DS</sub> =-24V, V <sub>GS</sub> =0V T <sub>J</sub> =85°C			-30	
On-State Drain Current	I <sub>D(on)</sub>	V <sub>DS</sub> ≥ -5V, V <sub>GS</sub> =-10V	25			A
Drain-Source On-Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =-10.0V, I <sub>D</sub> =-8.0A		40	55	mΩ
		V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-6.0A		58	75	
		V <sub>GS</sub> =-2.5V, I <sub>D</sub> =-4.0A		78	95	
Forward Transconductance	g <sub>FS</sub>	V <sub>DS</sub> =-10V, I <sub>D</sub> =-4.9A		10		S
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =-1.7A, V <sub>GS</sub> =0V		0.8	1.3	V
<b>Dynamic</b>						
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =-15V, V <sub>GS</sub> =-10V I <sub>D</sub> ≡-5.0A		10	18	nC
Gate-Source Charge	Q <sub>gs</sub>			1.6		
Gate-Drain Charge	Q <sub>gd</sub>			3.0		
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =-15V, V <sub>GS</sub> =0V f=1MHz		500		pF
Output Capacitance	C <sub>oss</sub>			100		
Reverse Transfer Capacitance	C <sub>rss</sub>			55		
Turn-On Time	t <sub>d(on)</sub>	V <sub>DD</sub> =-15V, R <sub>L</sub> =15Ω I <sub>D</sub> ≡-1.0A, V <sub>GEN</sub> =10V R <sub>G</sub> =6Ω		8	18	ns
	t <sub>r</sub>			8	18	
Turn-Off Time	t <sub>d(off)</sub>			25	50	
	t <sub>f</sub>			25	35	

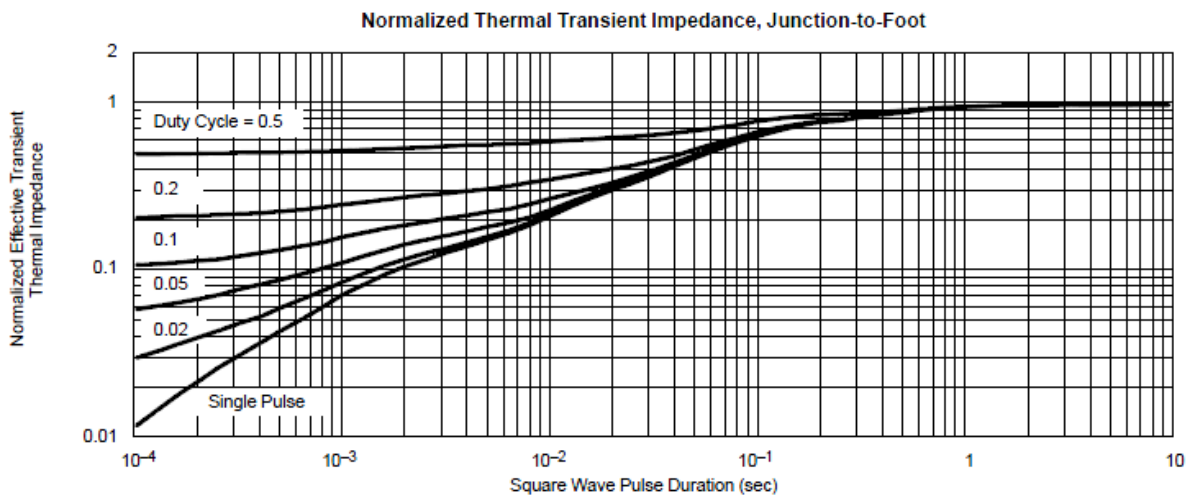
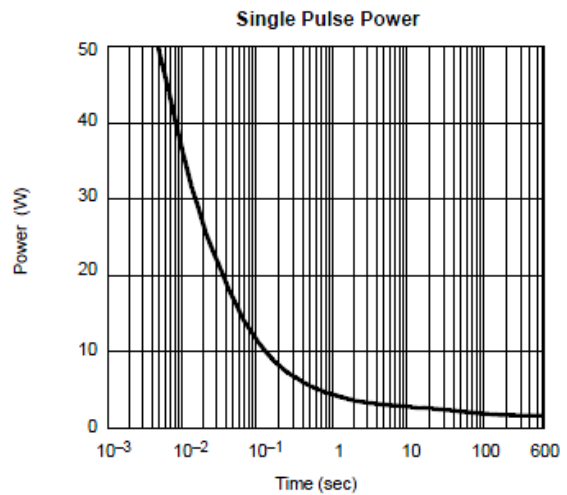
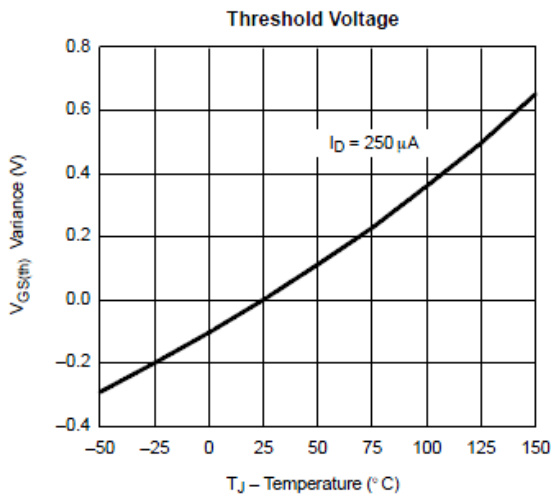
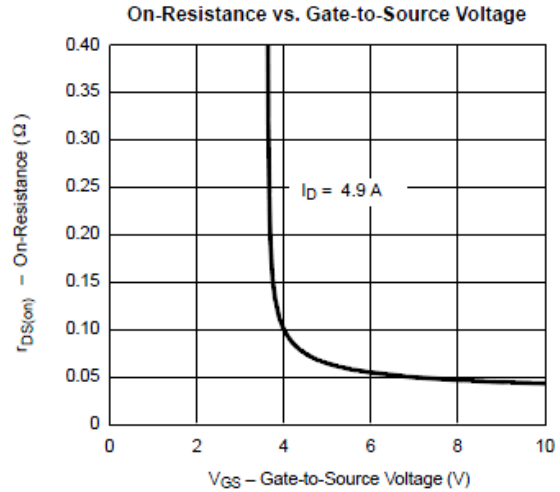
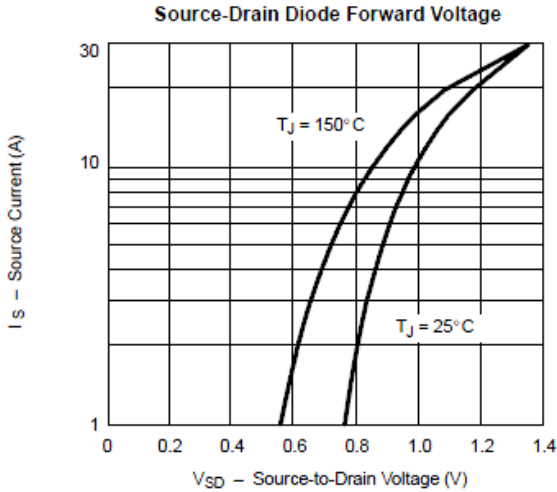


## Typical Characteristics





## Typical Characteristics





**Typical Characteristics**

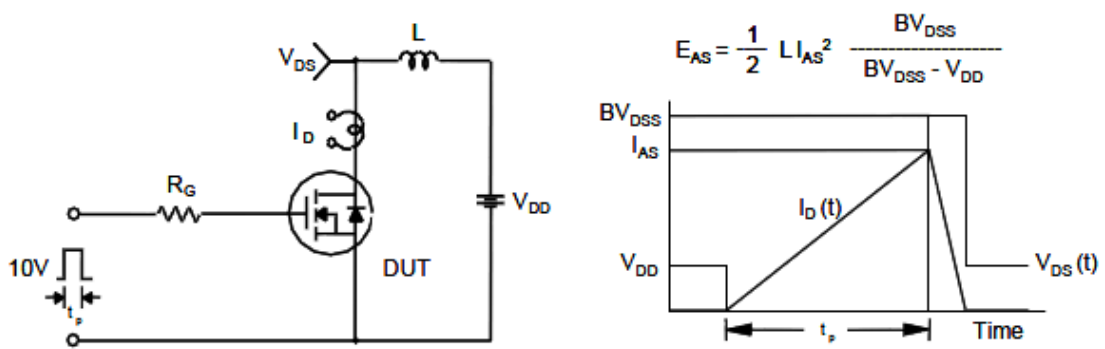
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms

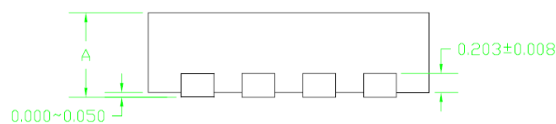
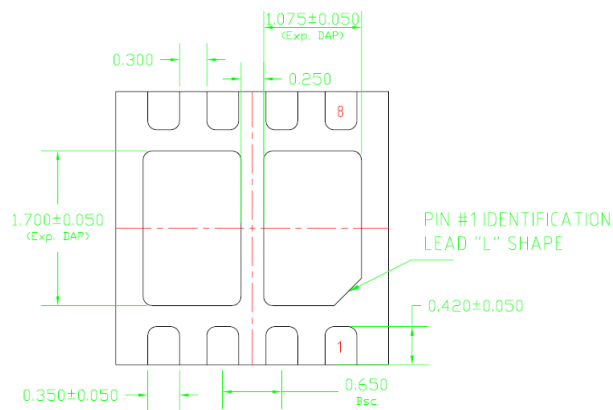
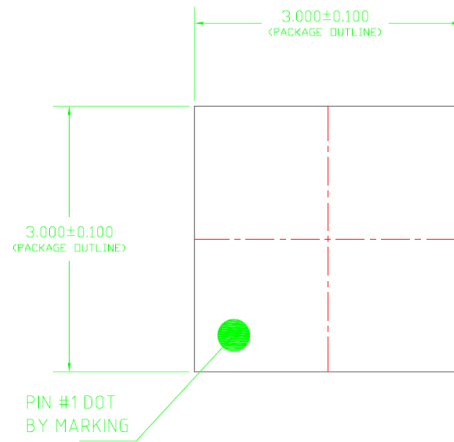


Unclamped Inductive Switching Test Circuit & Waveforms





**Package Information ( DFN3X3-8L )**



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